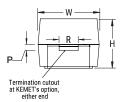


T493D337K006CT6110

T493 HRA, Tantalum, MnO2 Tantalum, HRA, 330 uF, 10%, 6.3 VDC, SMD, MnO2, Molded, High Reliability, C (0.01%/1000 Hrs), 500 mOhms, 7343, 3.1 mm, 1.3 mm

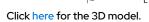
CATHODE (-) END VIEW



ANODE (+) END VIEW

BOTTOM VIEW Glue pad Shape/design at KEMETs option

SIDE VIEW



Dimensions	
L	7.3mm +/-0.3mm
W	4.3mm +/-0.3mm
н	2.8mm +/-0.3mm
т	0.13mm REF
S	1.3mm +/-0.3mm
F	2.4mm +/-0.1mm
A	3.8mm MIN
В	0.5mm +/-0.15mm
E	3.5mm REF
G	3.5mm REF
Р	0.5mm MIN
R	1mm REF
Х	0.1mm +/-0.1mm REF

Packaging Specifications	
Packaging	T&R, 178mm
Packaging Quantity	500

General Information	
Series	T493 HRA
Dielectric	MnO2 Tantalum
Style	SMD Chip
Description	SMD, MnO2, Molded, High Reliability
Features	High Reliability
RoHS	Yes
Termination	Tin
AEC-Q200	No
Typical Component Weight	412.33 mg
Notes	P and R dimensions represents the minimum solderable area of the termination surface entirely below cutout (if one is present).

Specifications	
Capacitance	330 uF
Tolerance	10%
Voltage DC	6.3 VDC (85C), 4.22 VDC (125C)
Temperature Range	-55/+125°C
Rated Temperature	85°C
Dissipation Factor	8% 120Hz 25C
Failure Rate	C (0.01%/1000 Hrs)
ESR	0.5 Ohms (100kHz 25C)
Ripple Current	548 mA (rms, 100kHz 25C)
Leakage Current	20.8 uA (5min 25°C)
Testing and Reliability	Standard Testing Only

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute – and we specifically disclaim – any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.